ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INFORMATION CONNECTING	PC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaration	ration of n encom	the substance the substance approximation of the substance app	es within th ver level m	ne manufactu aterials for v	urer listed it which the m	em. Not anufacti	e: if the item is an urer has engineerin	assembly with low g responsibility.		
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and Mi	ials and Mfg Information				
Supplier Information																
Company name* Co			Company unique ID			Unique ID Authority					Respons	Response Date*				
onsemi											2023-06-08					
Contact Name Title - Contact					Phone - Contact*					Email -	Email - Contact*					
Product-Env-Stewards Product			Product Enviro Compliance			NA				Product	Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Re			tle - Representative			Phone - Representative*				Email - I	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance			NA				Product	Product-Env-Stewards@onsemi.com							
Requester Item Number	r Item Number Mfr Item		n Number Mfr Item Name			Effective Date Version Manufacturing Sit		uring Site	١	Weight*	UOM	Unit Type				
	FAN73	FAN73832MX Half brid		alf bridge gate driver		2023-06-08	2023-06-08 TH2			80.792		mg	Each			
Aanufacturing Proccess Informa	tion					1					L. L		1	I		
Terminal Plating / Grid Array M	aterial	Terminal Base	Alloy	J-STD-020 MSL Rating		Peak Process Body Temper		ody Temperat	ure Max Time at Peak Ter		k Temperat	ature Number of Reflow Cycles				
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		C	30		secon	ds 3				
omments																
vel 1 - maximum time at peak temperat	ire during so	oldering is 10-3	0 seconds													
or more information regarding material	composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	1.144	mg	Supplier	Silver (Ag)	7440-22-4		0.9724	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1716	mg
Lead Frame	31.136	mg	Supplier	Zinc (Zn)	7440-66-6		0.0374	mg
			Supplier	Iron (Fe)	7439-89-6		0.7317	mg
			Supplier	Copper (Cu)	7440-50-8		30.3576	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	45.29	mg		Epoxy resin	proprietary data		2.7174	mg
			Supplier	Phenolic Resin	Proprietary Data		2.7174	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2264	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.4965	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.1322	mg
Plating	0.435	mg	Supplier	Palladium (Pd)	7440-05-3		0.0335	mg
			В	Nickel (Ni)	7440-02-0		0.3972	mg
			Supplier	Gold (Au)	7440-57-5		0.0043	mg
Wire Bond - Au	0.627	mg	Supplier	Gold (Au)	7440-57-5		0.627	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).